DECLARATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name; that

I verily believe I am the original, first and sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are named below) of the invention entitled:

MACROCAPSULES CONTAINING MICROENCAPSULATED PHASE CHANGE MATERIALS,

described and claimed

\underline{X} in the attached s	-						
	n filed	,					
as U.S. Application Seria							
and as amended	•						
I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).							
Pl	RIORITY CLAIM						
foreign application(s) for patent or inver-	ntor's certificate listed b ent or inventor's certific	elow and have also ate having a filing o	identified late before				
number Country	Day/Mo/Yr	Yes	No				
number Country	Day/Mo/Yr	Yes	No				
I hereby claim the benefit under Title 35 provisional application(s) listed below.	5, United States Code, §	119(e) of any Unite	ed States				
60/235,850	September 27, 2000						
Application No.	filed						
Application No.		Filing Date					

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Application Serial No.	Filing Date	Status
Application Serial No.	Filing Date	Status
11.C		

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I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under §1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

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